5mm Oval Red Super Bright LED Lamps

5mm Oval with AlGaInP dice ° Encapsulated with Red Diffused package ° Long Leads

Absolute Maximum Ratings : (Ta=25°C)

| Parameter | Symbol | Maximum Rating | Unit | | | |
|---|--------|------------------|------|--|--|--|
| Power Dissipation | PD | 100 | mw | | | |
| Reverse Voltage | VR | 5 | V | | | |
| Average Forward Current | Laf | 30 | mA | | | |
| Peak Forward Current (Duty=0.1,10KHZ) | IPF | 200 | mA | | | |
| Opertating Temperature Range | Topr | -20°C to +80 °C | | | | |
| Storage Temperature Range | Tstg | -40°C to +100 °C | | | | |
| Lead Soldering Temperature {1.6mm(0.063inch) From Body} 260°C For 3 Seconds | | | | | | |

Electro-Optical Characteristics ($Ta = 25^{\circ}C$)

| Parameter | Test Condition | Symbol | Min. | Тур. | Max. | Unit |
|--------------------|----------------------|----------------|------|-------|------|------|
| Forward Voltage | $I_F = 20 \text{mA}$ | VF | | 2.0 | 2.4 | V |
| Reverse Current | $V_R = 5V$ | IR | | | 10 | uA |
| Luminous Intensity | $I_F = 20mA$ | Iv | | 300 | | mcd |
| Wavelength | $I_F = 20 \text{mA}$ | λd | | 625 | 630 | nm |
| Spectral Bandwidth | $I_F = 20 \text{mA}$ | Δλ | | 18 | | nm |
| Viewing Angle | $I_F = 20mA$ | 2 0 1/2 | | 30/70 | | deg |

Item: 506(5.6mm oval)

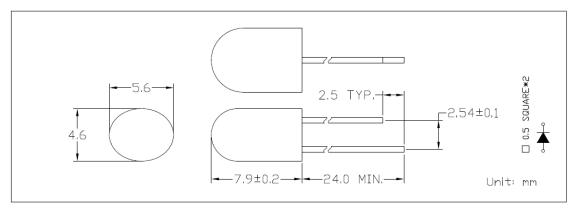
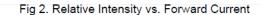
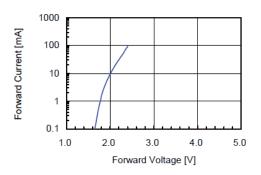


Fig 1. Forward Current vs. Forward Voltage





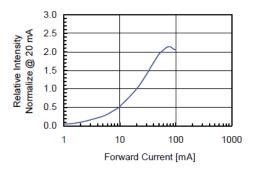
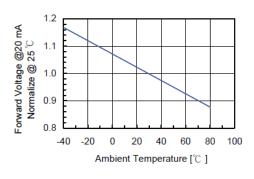


Fig 3. Forward Voltage vs. Temperature

Fig 4. Relative Intensity vs. Temperature



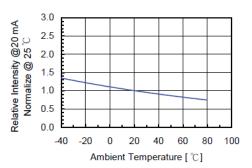
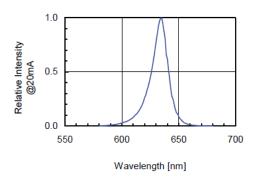


Fig 5. Relative Intensity vs. Wavelength



•Soldering:

1. Manual of soldering

The temperature of the iron tip should not be higher than 260

°Cand

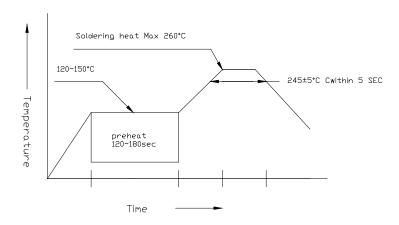
Soldering within 3 seconds per solder-land is to be observed

2. DIP soldering (Wave Soldering):

Preheating:120

°C~150°C within 5 sec.260°C(Max)

Gradual Cooling (Avoid quenching)



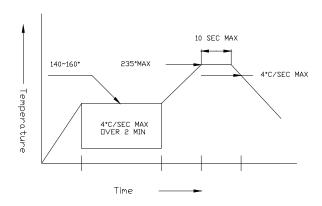
3. Reflow Soldering

Preheating:140

Operation heating:235

Gradual Cooling (Avoid quenching)

°C~160°C ±5°C, within 2 minutes.
°C(Max) within 10 seconds(Max)



•Handling:

Care must be taken not to cause to the epoxy resin portion of LEDS while it is exposed to high temperature.

Care must be taken not rub the epoxy resin portion of LEDS with hard or sharp article such as the sand blast and the metal hook